

2-24-04

03-05-2004

Form PTO-1595
(Rev. 10/02)
OMB No. 0651-0027 (exp. 6/30/2005)

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102685978

2003 P 50641 US

To the honorable Commissioner of Patents and Trademarks: Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):

Siva Chennupati

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

3. Nature of conveyance:

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Other

Execution Date: Feb. 13, 2004

2. Name and address of receiving party(ies)

Name: Infineon Technologies AG

Internal Address:

Street Address: St.-Martin-Strasse 53

City: Muenchen State: Germany

Zip: 81669

Additional name(s) & address(es) attached? ☐ Yes ☒ No

19270 U.S. PTO
10785140

022404

4. Application number(s) or patent number(s): 10785140

If this document is being filed together with a new application, the execution date of the application is: Feb. 13, 2004

A. Patent Application No.(s)

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name: Ira S. Matsil

Slater & Matsil, L.L.P.

Internal Address:

Street Address: 17950 Preston Rd.

Suite 1000

City: Dallas State: Texas Zip: 75252-5793

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 3.41). \$ 40.00

☐ Enclosed

☒ Authorized to be charged to deposit account

8. Deposit account number:

50-1065

(Attach duplicate copy of this page if paying by deposit account)

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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Ira S. Matsil, Reg. No. 35,272

Name of Person Signing

Signature

02/24/2004

Date

Total number of pages including cover sheet, attachments, and documents: 3

Mail documents to be recorded with required cover sheet information to:
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PATENT
REEL: 015025 FRAME: 0272

ASSIGNMENT

For good and valuable consideration, I, **Siva Chennupati**, residing at Hanshuber Strasse 12, Germering, Germany, 82110, a citizen of India;

hereby sell, assign, and transfer to Infineon Technologies AG, a corporation organized and existing under the laws of Germany, having its principal place of business at St.-Martin-Strasse 53, Muenchen, 81669, Germany;

hereinafter "Assignee", its successors, assigns and legal representatives, the entire right, title and interest in and for the United States and all foreign countries, in and to any and all improvements which are disclosed in the application for United States Letters Patent, which has been executed by the undersigned concurrently herewithin, and is entitled:

Circuit Module having Interleaved Groups of Circuit Chips

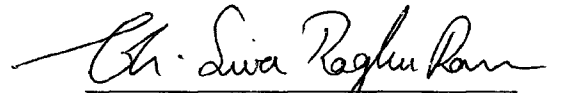
and in and to said application and all divisional, continuing substitute, renewal, reissue, and all other applications for Letters Patent which have been or shall be filed in the United States and all foreign countries on any of said improvements; and in and to all original and reissued patents which have been or shall be filed in the United States and all foreign countries on said improvements;

Agree that Assignee may apply for and receive Letters Patent for said improvements in its own name, and that, when requested, without charge to but at the expense of said Assignee, their successors, assigns, and legal representatives to carry out in good faith the intent and purpose of this agreement, the undersigned will execute all divisional, continuing substitute, renewal, reissue, and all other patent applications on any and all said improvements; execute all rightful oaths, assignments, powers of attorney and other papers; communicate to said Assignee, its successors, assigns, and representatives, all facts known to the undersigned relating to said improvements and the history thereof; and generally do everything possible which said Assignee, its successors, assigns, or representatives shall consider desirable for aiding in securing and maintaining proper patent protection for said improvements and for vesting title to said improvements and all

applications for patents and all patents on said improvements, in said Assignee, its successors, assigns, and legal representatives; and

Covenant with said Assignee, its successors, assigns and legal representatives that no assignment, grant, mortgage, license or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned, and that full right to convey the same as herein expressed is possessed by the undersigned.

Date: 13/02/2004


Siva Chennupati